

Introduction

QDR SRAM is a new memory technology defined by a number of leading memory vendors for high-performance and high-bandwidth communication applications. QDR is a synchronous pipelined burst SRAM with two separate unidirectional data buses dedicated for read and write operations running at double data rate. This reference design utilizes the ORCA® Series 4 library elements IODDR and HIODDR to create 178MHz double data rate read/write access to the QDR memory and targets for ORCA 4 FPGA and FPSC devices.

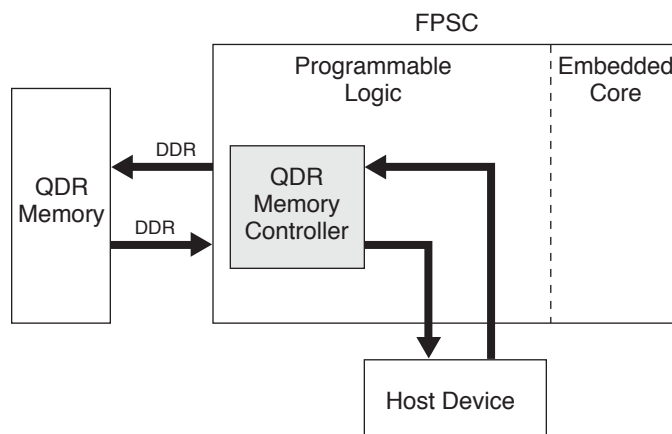
Features

- Support QDR-II memory
- Read/Write accesses at 178 MHz double data rate with -2 ORCA 4 FPGA/FPSC
- 32-bit, 16-bit and 8-bit write accesses
- Read access parity checking
- Implement QDR's HSTL1 I/Os using ORCA 4 programmable I/Os, no additional HSTL buffers required
- Fully simulated design using memory vendor's QDR simulation model

Functional Description

This QDR memory controller supports read/write accesses to 2Mx18 QDR-II memory. The pins of this design are divided into two interfaces, the host interface and the QDR interface. The host device accesses the QDR memory through the host interface and can be external to the ORCA 4 FPGA/FPSC or a module implemented inside the ORCA 4 FPGA/FPSC programmable logic. This design assumes the host device is an external device that accesses the QDR memory through the QDR memory controller using LVTTTL I/O standard. Figure 1 shows an example of how the controller is used when the design is targeted to an ORCA 4 FPSC.

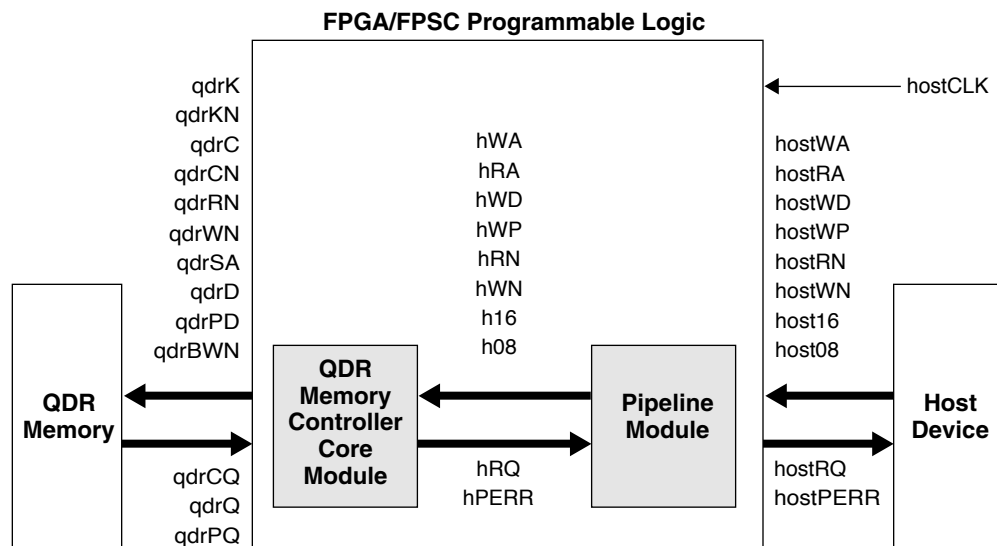
Figure 1. System Level Support Diagram



Double data rate allows data to be transferred on both rising and falling edges of the clock and therefore doubles the data throughput. The ORCA Series 4 FPGA/FPSC has an I/O shift register (IOSR) available for each group of four programmable I/O pads (PIOs). By proper instantiations of the IODDR/HIODDR library elements, IOSR and PIO are programmed to work together and transfer data on both clock edges. The IODDR/HIODDR library elements are on the QDR interface side. Because the host device is not in the programmable logic of the FPGA/FPSC, pipelines are added to the host interface side for increasing the total system performance. The pipelines are put into a separate module. If the host device is implemented in the programmable logic, this module may

be removed easily. As shown in Figure 2, all signals with the “qdr” prefix are QDR interface signals, and all signals with the “host” prefix are host interface signals. The signals with an “h” prefix are the signals after or before pipeline buffering.

Figure 2. Signal Names



The signal summary of the design is shown in Table 1.

Table 1. System Summary

Signal Name	I/O Type	I/O Standard	Function/Connection Description
hostCLK	I	LVTTL	System clock
hostWA[21:0]	I	LVTTL	Write address, sampled at hostCLK rising
hostRA[21:0]	I	LVTTL	Read address, sampled at hostCLK rising
hostWD[31:0]	I	LVTTL	Write data, sampled at hostCLK rising
hostWP[3:0]	I	LVTTL	Write parity, sampled at hostCLK rising
hostRN	I	LVTTL	Read cycle indication, active low, sampled at hostCLK rising
hostWN	I	LVTTL	Write cycle indication, active low, sampled at hostCLK rising
host16	I	LVTTL	16-bit access indication, active high, sampled at hostCLK rising, needs to be low for 8-bit and 32-bit access
host08	I	LVTTL	8-bit access indication, active high, sampled at hostCLK rising, needs to be low for 16-bit and 32-bit access
hostRQ[31:0]	O	LVTTL	Read data outputs
hostPERR[3:0]	O	LVTTL	Read data parity errors, active high, bit-3 for hostRQ[31:24], bit-2 for hostRQ[23:16], bit-1 for hostRQ[15:8], bit-0 for hostRQ[7:0]
qdrCQ	I	HSTL1	Connects to QDR “Output Echo Clock” CQ
qdrQ[15:0]	I	HSTL1	Read data, connects to QDR “Data Outputs” Q
qdrPQ[1:0]	I	HSTL1	Read parity, connects to QDR “Data Outputs” Q
qdrK	O	HSTL1	Connects to QDR “Input Clock” K
qdrKN	O	HSTL1	Connects to QDR “Input Clock” /K
qdrC	O	HSTL1	Connects to QDR “Input Clock for Output Data” C
qdrCN	O	HSTL1	Connects to QDR “Input Clock for Output Data” /C
qdrRN	O	HSTL1	Read control, connects to QDR “Read Control Pin” /R
qdrWN	O	HSTL1	Write control, connects to QDR “Write Control Pin” /W

Table 1. System Summary (Continued)

Signal Name	I/O Type	I/O Standard	Function/Connection Description
qdrSA[19:0]	O	HSTL1	Address, connects to QDR “Address Inputs” SA
qdrD[15:0]	O	HSTL1	Write data, connects to QDR “Data Inputs” D
qdrPD[1:0]	O	HSTL1	Write parity, connects to QDR “Data Inputs” D
qdrBWN[1:0]	O	HSTL1	Byte write enable, active low, connects to QDR “Block Write Control Pin” /BW[1:0]

Read Access Parity Checking

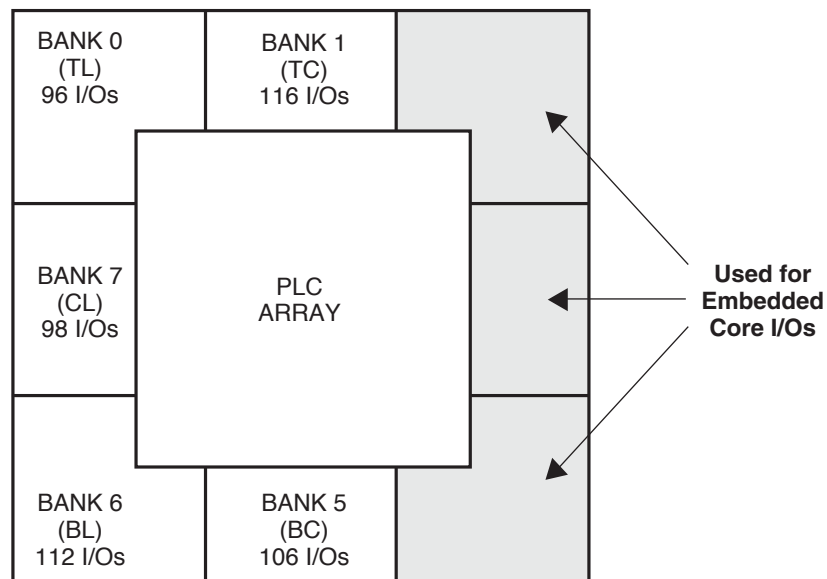
The memory controller contains a parity-checking feature that will be active only during read cycles. During write cycles the values sampled on hostWD[31:0] and hostWP[3:0] will be written into the QDR memory through qdrD[15:0] and qdrPD[1:0] signals respectively. In order to make the parity checking work properly, the host device needs to generate proper hostWP[3:0] values before the writes. The values of hostPERR[3:0] signals are obtained by the XOR (exclusive OR) results of the qdrQ[15:0] and qdrPQ[1:0] data read from the QDR memory.

Floorplanning

The controller design uses two different I/O standards, HSTL1 for the QDR interface and LVTTTL for the host interface. The required voltages for the design are shown in the table below.

I/O Standard	V _{DDIO} (V)	V _{REF} (V)	Number of I/Os Required for this Design
HSTL1	1.5	0.75	65
LVTTTL	3.3	NA	121

Because these two standards require different supply and input reference voltages, they can't be put into the same I/O bank. This design can be fit into any ORCA Series 4 FPGA or FPSC devices. For demonstration purpose, the ORSPI4 1036-ball fpSBGA package is chosen to be the target device. Figure 3 shows the available I/O banks and the number of I/Os in the banks of an ORSPI4 FPSC 1036 fpSBGA package. All HSTL1 I/Os in the design are put into I/O bank 7.

Figure 3. I/O Bank Assignments

Timing Waveforms

The QDR memory controller design has been verified through post-route timing simulation using the QDR memory Verilog simulation model from a memory vender. The following figures are the timing waveforms of the memory controller in read/write/nop operations running under 178MHz. For more detailed timing, please download the design and run the timing simulation.

Figure 4. READ and NOP Timing Waveforms

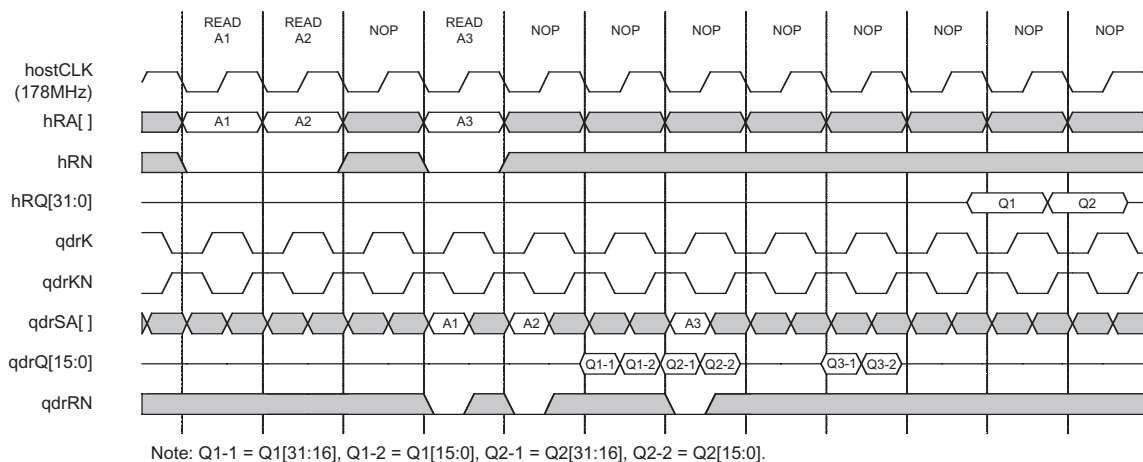
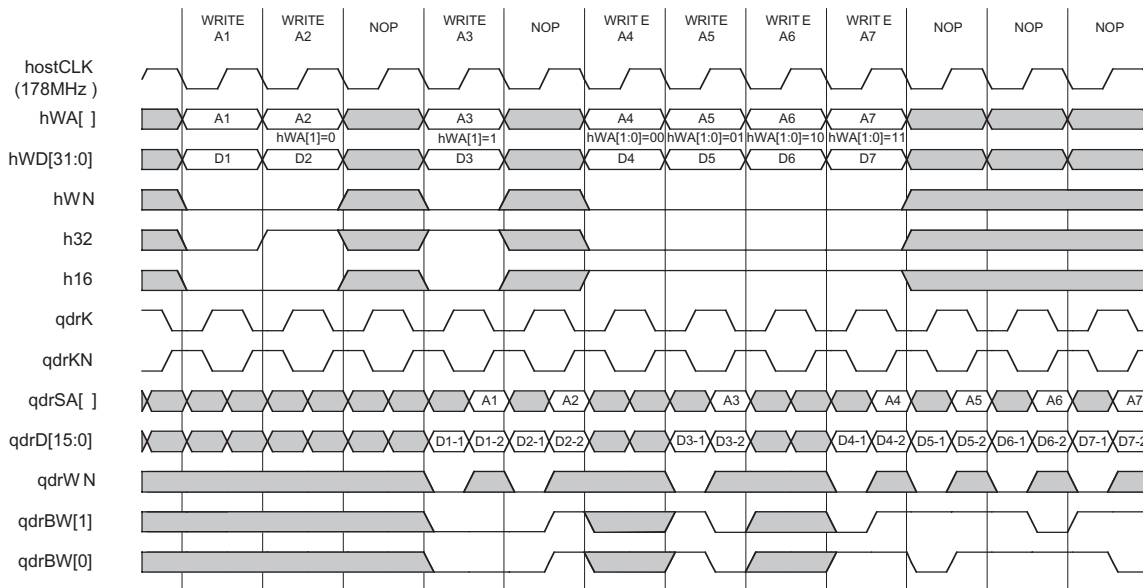
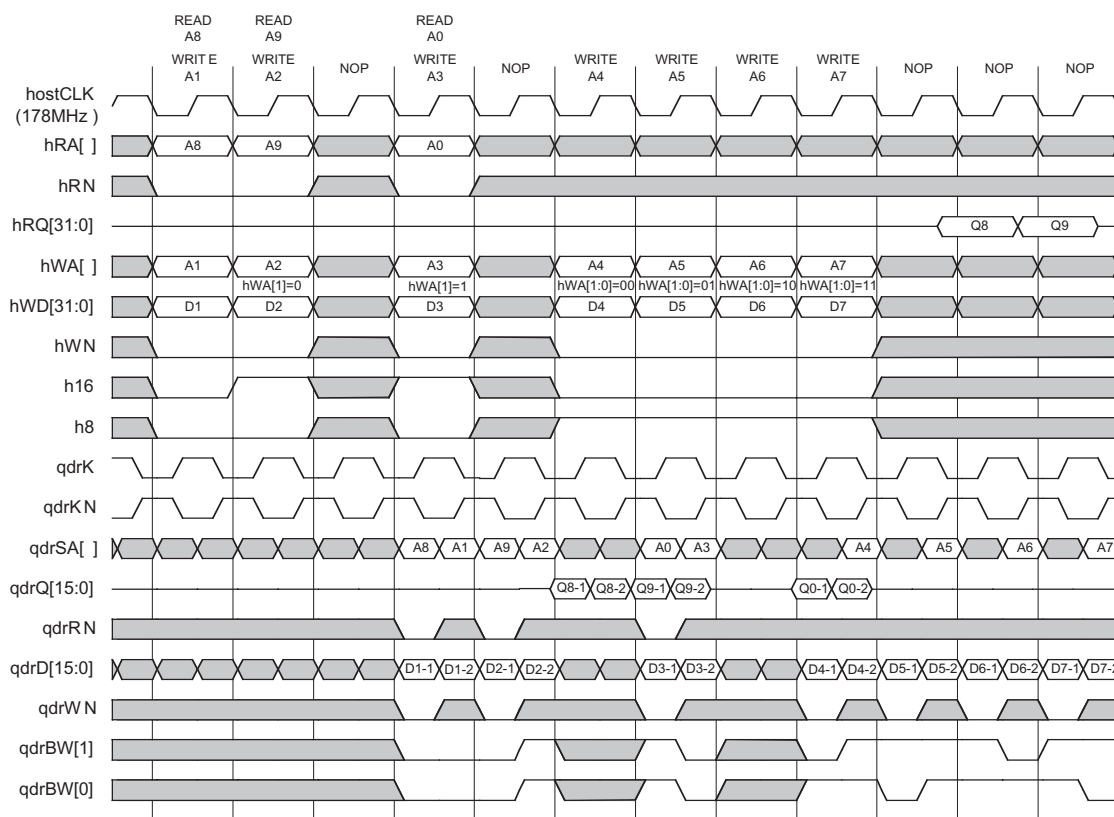


Figure 5. WRITE and NOP Timing Waveforms



Notes:

- According to h16 and h08 input values, the write cycles data width can be either 32-bit, 16-bit, or 8-bit. Write cycle A1 is a 32-bit write access. Write cycles A2 and A3 are 16-bit write accesses. Write cycles A4, A5, A6, A7 are 8-bit write accesses.
- $Dx-1 = Dx[31:16]$, $Dx-2 = Dx[15:0]$, where $x = 1, 2, 3, 4, 5, 6, 7$.
- Bit-1 of address A2 is 0. Write cycle A2 will write only D2[31:16] to the memory.
- Bit-1 of address A3 is 1. Write cycle A3 will write only D2[15:0] to the memory.
- Bit-1 and bit-0 of address A4 are 0 and 0 respectively. Write cycle A4 will write only D4[31:24] to the memory.
- Bit-1 and bit-0 of address A5 are 0 and 1 respectively. Write cycle A5 will write only D5[23:16] to the memory.
- Bit-1 and bit-0 of address A6 are 1 and 0 respectively. Write cycle A6 will write only D6[15:8] to the memory.
- Bit-1 and bit-0 of address A7 are 1 and 1 respectively. Write cycle A7 will write only D7[7:0] to the memory.

Figure 6. READ, WRITE and NOP Timing Waveforms

Notes:

1. Dx-1 = Dx[31:16]. Dx-2 = Dx[15:0], where x = 1, 2, 3, 4, 5, 6, 7.
2. Qy-1 = Qy[31:16]. Qy-2 = Qy[15:0], where y = 8, 9, 0.

Implementation

The design software used for this implementation is Lattice ispLEVER®. The following is the reference of implementation information of the design using Verilog language and Synplify synthesizer.

The source files and testbench are listed below:

1. Verilog Source:
 - qdr2_io.v Top-level file includes declarations of HSTL1 and LVTTTL I/O standards.
 - qdr2.v Main module of the QDR Memory Controller.
 - pipeline.v Pipeline module for increasing performance.
2. Testbench:
 - tb_qdr2.tf

Technical Support Assistance

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